

		Subclass	ISSUE CLASSIFICATION
		Class	

PATENT NUMBER

U.S. UTILITY Patent Application

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8577

H.H.	O.I.P.E.	PATENT DATE
SCANNED 	Q.A. 	

APPLICATION NO. 09/925427	CONT/PRIOR D F	CLASS 428	SUBCLASS 1	ART UNIT 1775	EXAMINER Jenkins
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Substrate material for mounting a semiconductor device, substrate for mounting a semiconductor device, semiconductor device, and method of producing the same

PTO-2040
12/99

ISSUING CLASSIFICATION

<input type="checkbox"/> TERMINAL DISCLAIMER	DRAWINGS			CLAIMS ALLOWED	
	Sheets Drwg.	Figs. Drwg.	Print Fig.	Total Claims	Print Claim for O.G.
<input type="checkbox"/> The term of this patent subsequent to _____ (date) has been disclaimed.				NOTICE OF ALLOWANCE MAILED	
	(Assistant Examiner) _____ (Date)				
<input type="checkbox"/> The term of this patent shall not extend beyond the expiration date of U.S Patent. No. _____ _____ _____				ISSUE FEE	
	(Primary Examiner) _____ (Date)			Amount Due	Date Paid
<input type="checkbox"/> The terminal ____ months of				ISSUE BATCH NUMBER	

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